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To the Director of the U.S. Patent and

document.

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1. Name of conveying party(ies):
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U.S. PTO
12/379307
02/18/2009

2. Name and Address of receiving party(ies):

SAMSUNG ELECTRO-MECHANICS CO., LTD.
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3. Nature of conveyance:

Assignment Merger
 Security Agreement Change of Name
 Other: _____

Execution Date(s): January 12, 2009

4. Application number(s) or patent number(s):

This document is being filed together with a new application.
 This document is being filed after filing of the application:

5. Name and address of party to whom correspondence concerning document should be mailed:

STAAS & HALSEY LLP Our Docket: 1954.1103
Attention: David M. Pitcher
1201 New York Ave., N.W., Suite 700
Washington, D.C. 20005

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41)..... (\$ 40.00 per Patent or Application in Assignment)

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8. Deposit Account No.: 19-3935

David M. Pitcher, Reg. No. 25,908
Name of Person Signing

Signature

February 18, 2009
Date

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U.S. ASSIGNMENT

SM 100

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by

SAMSUNG ELECTRO-MECHANICS CO., LTD.

ADDRESS: 314, Maetan 3-dong, Yeongtong-gu, Suwon, Gyunggi-do 443-743, Korea

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

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IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Typed Name & Signature of Inventor(s))

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